

Datasheet revision 1.1 <u>www.chipquik.com</u>

# Chip Quik Removal Alloy (4.5ft. In 9-6.5in. Lengths) leaded

### Product Highlights

Easily remove SMD parts with Chip Quik® removal alloy Reduce heat and reduce damage to circuit boards and SMD parts during removal Use with SMD291 flux

## Specifications

Alloy: Chip Quik® Melting Point:  $58^{\circ}\text{C } (136^{\circ}\text{F})$ 

| Chip Quik® Instructions |   |   |
|-------------------------|---|---|
|                         | 1 | Apply Chip Quik flux to all leads of SMD with syringe or flux applicator.   |
|                         | 2 | Melt Chip Quik low temperature alloy uniformly on all pins of SMD.  Maintain alloy in molten state long enough for complete reflow. |
|                         | 3 | Lift chip from board with dental pick or vacuum pen.  |
|                         | 1 | Thoroughly clean site with swab dipped in flux while applying heat.  Clean thoroughly with alcohol pad.                             |

### (With solder iron or warm air bath)

- Apply flux to all leads.
- Melt CHIP QUIK® uniformly on all pins.
- Maintain alloy in molten state long enough to release chip.
- Lift chip from board with dental pick or vacuum pen.

#### **CLEAN UP**

- While molten, use cotton swab and flux to move excess to an unused section of board.
- While applying heat, polish each pad with a swab and flux until thoroughly clean.
- At room temperature, clean residue with alcohol pad.
- You are now ready to install the new chip.

### 2.5 ft of Chip Quik® material, removes 1250 to 1500 SMD pins.

Conforms to the following Industry Standards:

J-STD-006C, Amendments 1 & 2 (Solder Alloys and Fluxed/Non-Fluxed Solders): Yes RoHS 2 Directive 2011/65/EU: No